



Above and Beyond Scholarship | Spring 2022

The Associated Students of Moorpark College (ASMC) Board of Directors is excited to award its *Above and Beyond Scholarship* to Moorpark College students who are making an impact in their community while maintaining high academic standing. Those that are involved in community service and have a minimum cumulative GPA of 3.2 are encouraged to apply.

A total of five (5) students will be awarded \$1,320 each for the Above and Beyond Scholarship.

ELIGIBILITY REQUIREMENTS:

Moorpark College (MC) students are encouraged to apply for this scholarship if they:

- Have completed at least 12 units total at MC over the course of the last two semesters, and are currently enrolled in a minimum of 6 units at MC for Spring 2022;
- Have earned a cumulative Grade Point Average (GPA) of 3.2 or higher at MC; and
- Have made a positive difference in their communities through leadership, campus involvement, or local civic engagement.

HOW TO APPLY:

In addition to completing the *Above and Beyond Scholarship* application (next page), interested students are also asked to include the following three (3) **required** documents (failure to include any of the following documents will result in automatic disqualification from consideration):

1. **A response to the following prompts, no longer than 350 words each:**
 - A. What community service activities have you participated in?
 - B. Which community service activity has personally impacted you the most and why?
 - C. Please describe your career and educational goals.
2. **A copy of your resume.** Your resume should be no more than two pages in length, and it should include any participation in leadership opportunities, achievements or special distinctions, and professional or volunteer experience you have accumulated while attending Moorpark College.
3. **A copy of your current, unofficial transcript.** Unofficial transcripts are available to students with ID through the Moorpark College Admissions & Records Office, which is located on the 1st floor of Fountain Hall. Course information downloaded from DegreeWorks will not be accepted.

To allow for a blind review of students' application materials, we ask that you please redact identifying information, such as your name, from the aforementioned required documents before submitting.

Applicants should submit the *Above and Beyond* application sheet (next page), written prompt responses, resume, and unofficial transcript to MC Scholarship Technician Maria Perez-Medeiros at mmedeiros@vccd.edu. Students may also submit hardcopies of their application materials to the Scholarship Office mailbox, located in the Administration Building. Materials for this scholarship cannot be submitted via the MC Scholarship portal.

Questions? Contact ASMC Director of Academic Affairs Christopher Ojeda (ASMCAcademicAffairs@vccd.edu) with any questions you may have about the eligibility and application requirements for the *Above and Beyond Scholarship*. You can also contact Maria Perez-Medeiros of the MC Scholarships Office if you have questions about the application process or about MC scholarships in general (mmedeiros@vccd.edu).

APPLICATION DEADLINE:

Physical printed applications or electronically submitted are due on **Friday, March 11, 2022.**

ASMC Above and Beyond Scholarship Application | Spring 2022

Please complete this page and submit it with the additional supplemental documentation (short-answer responses, resume, and unofficial transcripts) by the **Friday, March 11, 2022** deadline.

STUDENT INFORMATION:

First Name:	Last Name:
MC Student ID number (900-):	MyVCCCD Email Address:

ACADEMIC INFORMATION:

Units Completed:	Units in Progress:	Cumulative GPA:	Academic Majors:

CHECKLIST:

Before submitting your application for consideration, please check that you have included the following:

- ✓ Personal statement (no more than 350 words for each prompt)
- ✓ A copy of your resume (maximum of 2 pages)
- ✓ A copy of your current, unofficial transcripts (not copied and pasted from DegreeWorks!)
- ✓ This application form with your information and signature

For the convenience of the application reviewing committee, **please avoid stapling documents together, and please replace all occurrences of your name with your 900 number.**

SIGNATURE:

By signing, I certify that the information contained herein is true and correct to the best of my knowledge and understand that it is subject to verification. I give ASMC permission to verify my GPA, confirm units completed, and check other academic measures as necessary to establish my eligibility for this scholarship.

Signature

Date

